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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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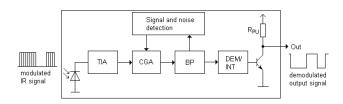


DATASHEET

Infrared Receiver Control Receiver Module EAIRMLA3



Block Diagram



Features

- · High shielding against electric field disturbance.
- · Circular lens to improve the receive characteristic.
- · Line-up for various center carrier frequencies.
- · Low voltage and low power consumption.
- · High immunity against ambient light.
- · Photodiode with integrated circuit.
- TTL and CMOS compatibility.
- · Side-received SMD.
- Suitable burst length ≥ 10 pulses/burst.
- This product itself will remain within RoHS compliant version.
- · Pb free.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

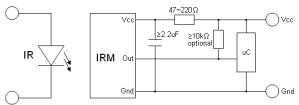
- The device is miniature SMD type infrared receiver that has been developed and designed by utilizing the latest IC technology.
- The PIN diode and preamplifier are assembled onto a lead frame and molded into an epoxy package which operated an IR filter. The demodulated output signal can directly be decoded by a microprocessor.

Applications

- · Light detecting portion of remote control
- · AV instruments such as Audio, TV, VCR, CD, MD, etc
- · Home appliances such as Air-conditioner, Fan, etc
- 0ther devices using IR remote control
- · CATV set top boxes
- Multi-media Equipment



Application Circuit



Parts Table

Model No.	Carrier Frequency	
EAIRMLA3	38 kHz	

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	6	V
Operating Temperature	Topr	-20 ~ +80	$^{\circ}$ C
Storage Temperature	Tstg	-40 ~ +85	$^{\circ}\!\mathbb{C}$

^{*1 4}mm from mold body for less than 5 seconds



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Current consumption	lcc	-	-	1.2	mA	No input signal
Supply voltage	V _{CC}	2.7	-	5.5	V	
Peak wavelength	λ_{p}		940		nm	
Reception range	L ₀	8			m	
	L ₄₅	5				
Half angle(horizontal)	ϕ_{h}		±45		deg	At the ray axis
Half angle(vertical)	φν		±45		deg	*1
High level pulse width	Тн	400	-	800	μs	At the ray axis
Low level pulse width	T _L	400	-	800	μs	*2
High level output voltage	V _{OH}	2.7			V	
Low level output voltage	V_{OL}		0.2	0.5	V	

Notes:

^{*1 :} The ray receiving surface at a vertex and relation to the ray axis in the range of θ = 0° and θ =45°.

^{*2 :} A range from 30cm to the arrival distance. Average value of 50 pulses.



Test method

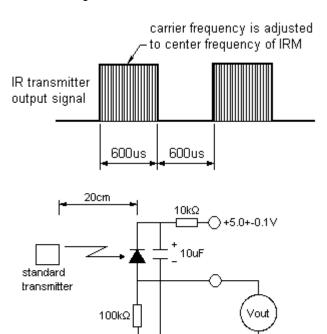
The specified electro-optical characteristics are valid under the following conditions.

- 1. Measurement environment
 - A place without extreme light reflections.
- 2. External light

The environment contains an ordinary, white fluorescent lamp without high frequency modulation. The color temperature is 2856K and the illumination at the IR receiver is less than 10 Lux ($Ev \le 10$ Lux).

- 3. Standard transmitter
 - The test transmitter is calibrated by using the circuit shown in figure 2. The radiation intensity of the transmitter is adjusted until **Vo=400mVp-p.** Both, the test transmitter and the photo diode, have a peak wavelength of 940nm. The photo diode for calibration is PD438B (λp=940nm, Vr=5V).
- 4. The measurement system is shown in Fig.-3

Fig.-1 Transmitter Wave Form



D.U.T output Pulse

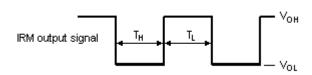
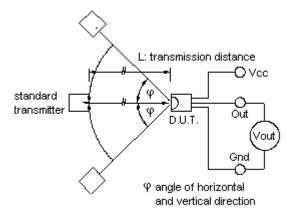


Fig.-3 Measuring System



Oscilloscope



Typical Electro-Optical Characteristics Curves

Fig.-4 Relative Spectral Sensitivity vs. Wavelength

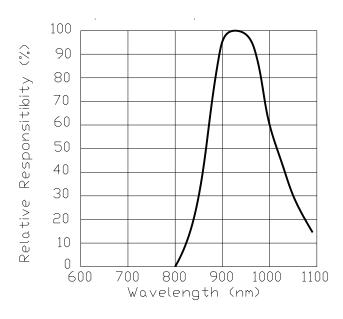


Fig.-5 Relative Transmission Distance vs. Direction

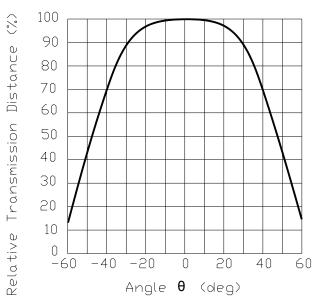
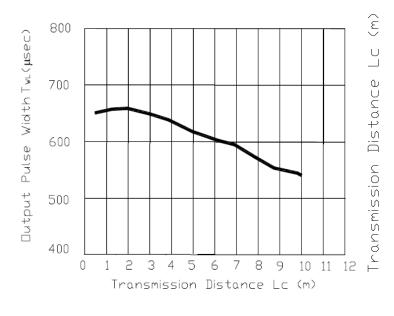


Fig.-6 Output Pulse Length vs. Arrival Distance Fig.-7 Arrival Distance vs. Supply Voltage



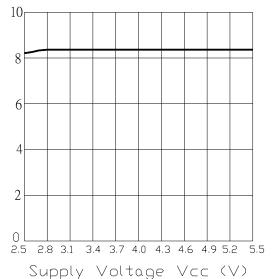
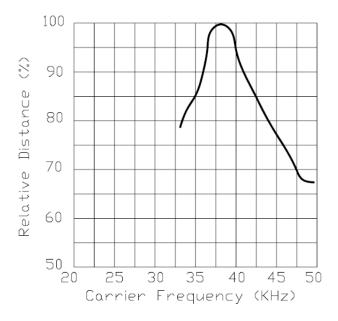


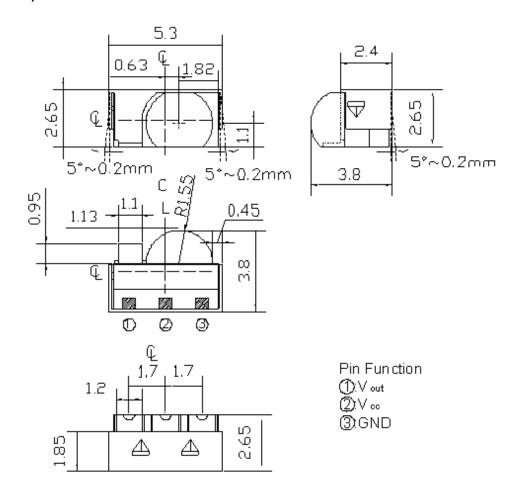


Fig.-8 Relative Transmission Distance vs. Center Carrier Frequency

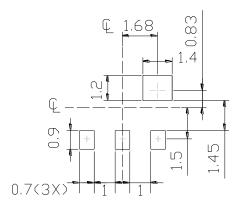




Package Dimension (Dimensions in mm)



Note :Tolerances unless dimensions $\pm\,0.3$ mm. Recommended pad layout for surface mount leadform

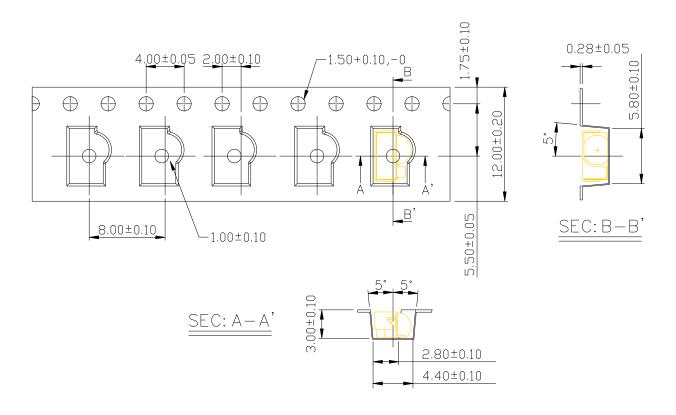




Code information

Protocol	Suitable	Protocol	Suitable
JVC	No	RCA	No
Matsushita	Yes	Sharp	Yes
Mitsubishi	No	Sony 12 Bit	Yes
NEC	Yes	Sony 15 Bit	No
RC5	Yes	Sony 20 Bit	No
RC6	Yes	Toshiba	Yes
RCMM	No	Zenith	Yes
RCS-80	No	Continuous Code	No

Tape & Reel Packing Specifications (Dimensions in mm)



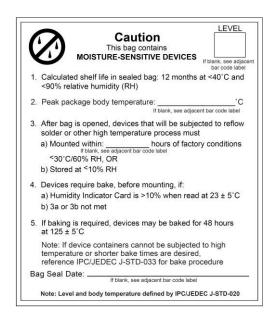
Packing Quantity

2000 pcs / Reel 5 Reels / Carton



Label format





Moisture Classification-storage and used condition label

Recommended method of storage

The following are general recommendations for moisture sensitive level (MSL) 4 storage and use:

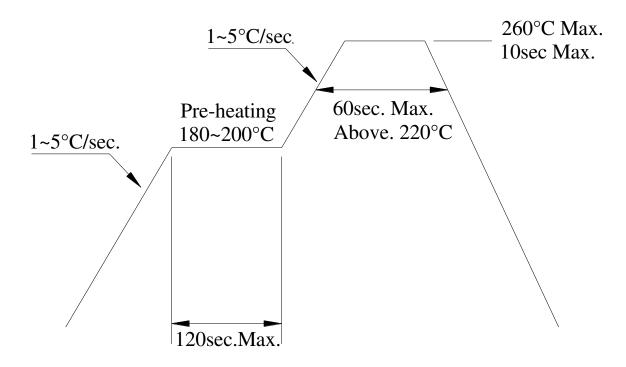
- 1. Shelf life in sealed bag from the bag seal date: 12 months at < 40 °C and < 90% relative humidity (RH)
- 2. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must mounted within 72 hours of factory conditions < 30 °C/60%RH.
- 3. If the moisture absorbent material (silica gel) has faded away or the IRM has exceeded the storage time. Baking treatment is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the conditions: 60±5°C for 96 hours.

ESD Precaution

Proper storage and handing procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Anti-static bag. Electro-Static Sensitive Devices warning labels are on the packing.



Solder Reflow Temperature Profile



Note:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the IRM device during heating.
- 3. After soldering, do not warp the circuit board.

Application Restrictions

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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